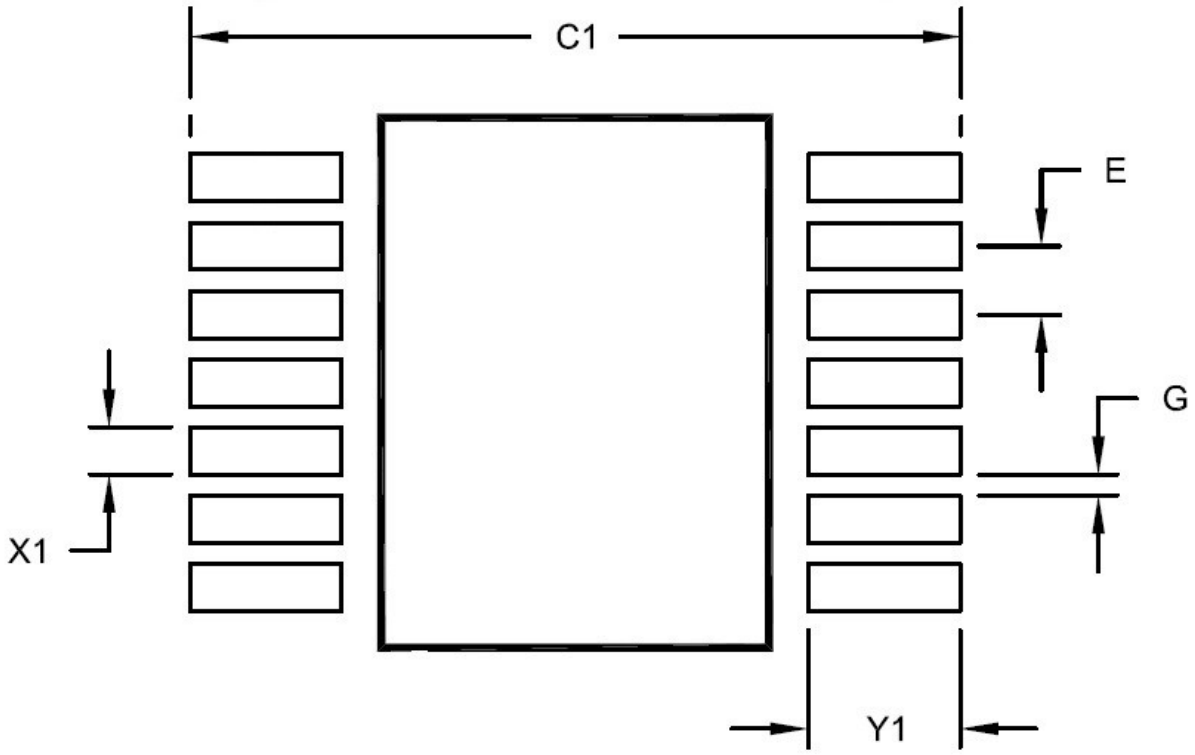
Hermann Ulrich - Industrieservice | Hans-Kohl-Str. 13 | D-64646 Heppenheim
Mobil: +49-151-64537021 | Email: h-ulrich@pcb-devboards.de | www.pcb-devboards.de

TSSOP / QSOP / TSOP 16 to DIL16 (0.3“)

Units		MILLIMETERS		
Dimension Limit		MIN	NOM	MAX
Contact Pitch	E		0.65	
Contact Pad Spacing	C1	7.75		14.80
Contact Pad Width	X1		0.45	
Contact Pad Length	Y1		1.80	
Distance Between Pads	G		0.20	

Top View (SMD Footprint)



DIL Pin Type:

1. Version: Wire Wrap Pins 0.64x0.64 mm
2. Version: Machine Pins Ø 0.47 mm

PCB dimensions: 21mm x 10.8mm

Datasheet rev.: 1.01